

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Rajiv V. Joshi</td> <td>04/07/2006</td> </tr> <tr> <td>Louis C. Hsu</td> <td>04/06/2006</td> </tr> <tr> <td>Oleg Gluschenkov</td> <td>04/05/2006</td> </tr> </tbody> </table>		Name	Execution Date	Rajiv V. Joshi	04/07/2006	Louis C. Hsu	04/06/2006	Oleg Gluschenkov	04/05/2006		
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RECEIVING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>International Business Machines Corporation</td> </tr> <tr> <td>Street Address:</td> <td>New Orchard Road</td> </tr> <tr> <td>City:</td> <td>Armonk</td> </tr> <tr> <td>State/Country:</td> <td>NEW YORK</td> </tr> <tr> <td>Postal Code:</td> <td>10504</td> </tr> </table>		Name:	International Business Machines Corporation	Street Address:	New Orchard Road	City:	Armonk	State/Country:	NEW YORK	Postal Code:	10504
Name:	International Business Machines Corporation										
Street Address:	New Orchard Road										
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PROPERTY NUMBERS Total: 1											
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Application Number:	12541641										
CORRESPONDENCE DATA											
<p>Fax Number: (703)481-0585</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (703) 481-0532</p> <p>Email: bill@cwpeterson.com</p> <p>Correspondent Name: Charles W. Peterson, Jr.</p> <p>Address Line 1: 435B Carlisle Dr.</p> <p>Address Line 4: Herndon, VIRGINIA 20170</p>											
ATTORNEY DOCKET NUMBER:	YOR920040562US4										
NAME OF SUBMITTER:	Charles W. Peterson, Jr.										
<p>Total Attachments: 3</p> <p>source=YOR920040562US4_FiledAssignment (10-4-07)#page1.tif</p> <p>source=YOR920040562US4_FiledAssignment (10-4-07)#page2.tif</p>											

CH \$40.00 12541641

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PATENT
REEL: 023102 FRAME: 0842

IBM Docket No: YOR920040562US1

Assignment

INVENTOR
AND CITY

Whereas, I/WE
Rajiv V. Joshi
County of Westchester

of Yorktown Heights
and State of NY

Louis C. Hsu
County of Dutchess

of Fishkill
and State of NY

Oleg Gluschenkov
County of Dutchess

of Poughkeepsie
and State of NY

have invented certain improvements in

TITLE **INTEGRATED CIRCUIT CHIP WITH FETS HAVING MIXED BODY THICKNESSES
AND METHOD OF MANUFACTURE THEREOF**

and executed herewith, a United States patent application therefor;

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said applications to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed

CITY AND at April 8
DATE on , 2006,

<i>Rajiv</i>	<i>V.</i>	<i>Joshi</i>	SIGNATURE
Rajiv	V.	Joshi	
FIRST NAME	MIDDLE INITIAL	LAST NAME	

Signed and sealed

CITY AND at _____
DATE on , 2006,

<div style="text-align: right;">SIGNATURE</div>		
Louis	C.	Hsu
FIRST NAME	MIDDLE INITIAL	LAST NAME

Signed and sealed

CITY AND at _____
DATE on _____, 2006.

Olc FIRST NAME MIDDLE INITIAL Gluschenkov LAST NAME SIGNATURE

PATENT
REEL: 023102 FRAME: 0844

IBM Docket No: YOR920040562US1

Assignment

INVENTOR Whereas, I/WE

AND CITY Rajiv V. Joshi of Yorktown Heights
 County of Westchester and State of NY

 Louis C. Hsu of Fishkill
 County of Dutchess and State of NY

 Oleg Gluschenkov of Poughkeepsie
 County of Dutchess and State of NY

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Signed and sealed

CITY AND at _____
 DATE on _____, 2006, _____ SIGNATURE

 Rajiv V. Joshi
 FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed

CITY AND at Hopewell Jct. New York
 DATE on 4/6, 2006, Louis C. Hsu SIGNATURE

 Louis C. Hsu
 FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed

CITY AND at _____
 DATE on _____, 2006, _____ SIGNATURE

 Oleg Gluschenkov
 FIRST NAME MIDDLE INITIAL LAST NAME

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AssignmentINVENTOR
AND CITY

Whereas, I/WE

Rajiv V. Joshi
County of Westchesterof Yorktown Heights
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Signed and sealed

CITY AND at _____
DATE on _____, 2006,

Rajiv V. Joshi
FIRST NAME MIDDLE INITIAL LAST NAME SIGNATURE

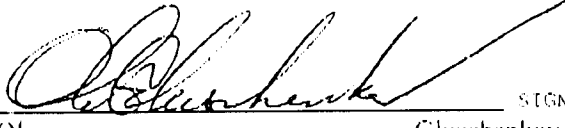
Signed and sealed

CITY AND at _____
DATE on _____, 2006,

Louis C. Hsu
FIRST NAME MIDDLE INITIAL LAST NAME SIGNATURE

Signed and sealed

CITY AND at East Fishkill, NY
DATE on April 5, 2006,


Oleg Gluschenkov
FIRST NAME MIDDLE INITIAL LAST NAME SIGNATURE